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3.3V, Wide Bandwidth, 4-Channel, 2:1 Mux/DeMux Video Switch with Single Enable

Features

• R_{ON} is 4Ω typical

• Low bit-to-bit skew: 200ps

• Low crosstalk: -27dB @ 250MHz

• Low Current Consumption: 20µA

• Near-Zero propagation delay: 250ps

· Switching speed: 9ns

• Channel On-Capacitance: 9.5pF (typical)

• V_{CC} Operating Range: +3.0V to +3.6V

• ESD>2000V . . . Human Body Model

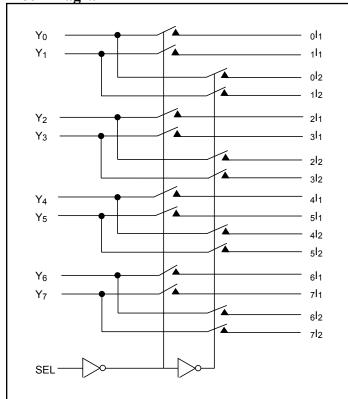
• >500 MHz bandwidth (or data frequency)

Packaging (Pb-free & Green available):
 48-pin, 240-mil wide plastic TSSOP (A)

Applications

Routes physical layer signals for high bandwidth digital video

Block Diagram



Description

Pericom Semiconductor's PI3DBV series of logic circuits are produced using the Company's advanced sub-micron CMOS technology, achieving industry leading performance.

The PI3DBV40 is a 8- to 4-channel multiplexer/demultiplexer. Industry leading advantages include a propagation delay of less than 250ps, resulting from its low channel resistance and I/O capacitance. The device multiplexes differential outputs from a video source to one of two corresponding outputs or switches two inputs to a common display. The switch is bidirectional and offers little or no attenuation of the high-speed signals at the outputs. It is designed for low bit-to-bit skew, high channel-to-channel noise isolation and is compatible with various standards, such as LVDS and TMDS.

Pin Description

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I in Description		
		_
V _{DD}	1	48 011
Y ₀	2	47 🛘 111
GND [3	46 🛘 GND
Y ₁	4	45 1 0l2
GND [5	44 112
V _{DD}	6	43 GND
GND [7	42 2l ₁
Y ₂	8	41 3l ₁
GND [9	40 GND
Y ₃ [10	39 212
GND [11	38 🗖 3l ₂
V _{DD}	12	37 GND
GND [13	36 🕽 V _{DD}
NC [14	35 411
Y ₄ [15	34 D 5l1
GND [16	33 GND
Y ₅ [17	32 412
GND [18	31 512
V _{DD} [19	30 GND
GND [20	29 1 6l ₁
Y ₆ [21	28 711
GND [22	27 GND
Y ₇ [23	26 D 6l2
SEL C	24	25 712
		-



Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature65°C to +150°C Supply Voltage to Ground Potential0.5V to +4.0V
DC Input Voltage–0.5V to +5.5V
DC Output Current
Power Dissipation0.5W
1 Ower Dissipation

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Truth Table

Function	SEL
Y _N to _N I ₁	L
Y _N to _N I ₂	Н

DC Electrical Characteristics for Video Switching over Operating Range

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C, V_{CC} = 3.3V \pm 10\%)$

Paramenter	Description	Test Conditions	Min.	Typ. ⁽²⁾	Max.	Units
V_{IH}	Input HIGH Voltage	Guaranteed HIGH level	2	-	1	
V_{IL}	Input LOW Voltage	Guaranteed LOW level	-0.5	-	0.8	V
V_{IK}	Clamp Diode Voltage	$V_{CC} = Max.$, $I_{IN} = -18mA$	-	-0.7	-1.2	
I_{IH}	Input HIGH Current	$V_{CC} = Max., V_{IN} = V_{CC}$	-	-	±5	
${ m I}_{ m IL}$	Input LOW Current	$V_{CC} = Max., V_{IN} = GND$	-	-	±5	μΑ
I_{OFF}	Power Down Leakage Current	$VCC = 0V, V_Y = 0V, V_I \le 3.6$	-	-	±5	
R _{ON}	Switch On-Resistance(3)	$\label{eq:VCC} \begin{split} V_{CC} &= Min., \ 1.5V \leq V_{IN} \leq V_{CC}, \\ I_{IN} &= -40 mA \end{split}$	-	4	8	
R _{FLAT(ON)}	On-Resistance Flatness ⁽⁴⁾	V_{CC} = Min., VIN @ 1.5V and V_{CC} , I_{IN} = -40mA	-	1	ı	Ω
ΔR_{ON}	On-Resistance match from center ports to any other port(4)	$\begin{aligned} V_{CC} &= Min., \ 1.5V \leq V_{IN} \leq V_{CC}, \\ I_{IN} &= -40 mA \end{aligned}$	-	0.9	2	

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Capacitance ($T_A = 25$ °C, f = 1MHz)

Parameters ⁽⁴⁾	Description	Test Conditions	Тур.	Max.	Units
C_{IN}	Input Capacitance		3.1	3.6	
C _{OFF}	Port I Capacitance, Switch OFF	$V_{IN} = 0V$	2.8	6.0	pF
C _{ON}	Switch Capacitance, Switch ON		9.5 ⁽⁵⁾	10.9	

Notes:

- 1. For max, or min, conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$ ambient and maximum loading.
- 3. Measured by the voltage drop between A and B pins at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the two (A & B) pins.
- 4. This parameter is determined by device characterization but is not production tested.
- 5. Measured on worst case corner pin.

Power Supply Characteristics

Pa	rameters	Description	Test Conditions ⁽¹⁾	Min.	Typ.(2)	Max.	Units
I_{CC}		Quiescent Power Supply Current	$V_{CC} = Max., V_{IN} = GND \text{ or } V_{CC}$	-	-	800	μΑ

Notes:

- 1. For max. or min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$ ambient and maximum loading.

Dynamic Electrical Characteristics Over the Operating Range (TA=-40° to +85°C, VCC=3.3V±10%, GND=0V)

•			_	,		
Parameter	Description	Test Conditions	Min.	Typ. ⁽²⁾	Max.	Units
X _{TALK}	Crosstalk	f = 250MHz, See Fig. 2	-	-27	-	dB
O _{IRR}	OFF Isolation	f = 250MHz, See Fig. 3	-	-32	-	uБ
BW	Bandwidth –3dB	See Fig. 1, Fig. 4	-	500	-	MHz

Switching Characteristics

Paramenter	Description	Min.	Typ.(2)	Max.	Units
t_{PD}	Propagation Delay(2,3)	-	0.25		
t _{PZH} , t _{PZL}	Line Enable Time - SEL to Y _N , I _N	0.5	-	15	
t _{PHZ} , t _{PLZ}	Line Disable Time - SEL to Y _N , I _N	0.5	-	9	ns
t _{SK(o)}	Output Skew between center port (Y4 to Y5) to any other port(2)	-	0.1	0.2	113
t _{SK(p)}	Skew between opposite transitions of the same output (t _{PHL} - t _{PLH}) (2)	-	0.1	0.2	

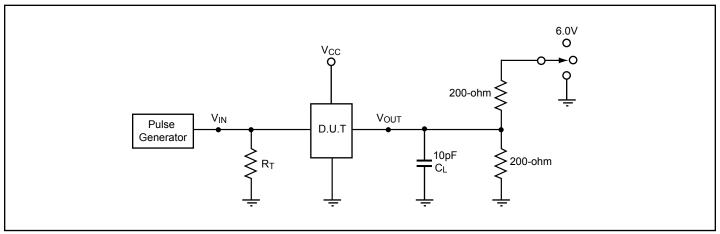
Notes:

- 1. For max. or min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Guaranteed by design
- 3. The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 10pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interactions with the load on the driven side.

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Test Circuit for Electrical Characteristics⁽¹⁾



Notes:

- 1. $C_L = Load$ capacitance: includes jig and probe capacitance.
- 2. R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator
- 3. All input impulses are supplied by generators having the following characteristics: f = 10 MHz, $Z_O = 50\Omega$, $t_R \le 2.5$ ns, $t_F \le 2.5$ ns.
- 4. The outputs are measured one at a time with one transition per measurement.

Switch Positions

Test	Switch
t _{PLZ} , t _{PZL} (output on I-side)	6.0V
t _{PHZ} , t _{PZH} (output on I-side)	GND
Prop Delay	Open

Test Circuit for Dynamic Electrical Characteristics

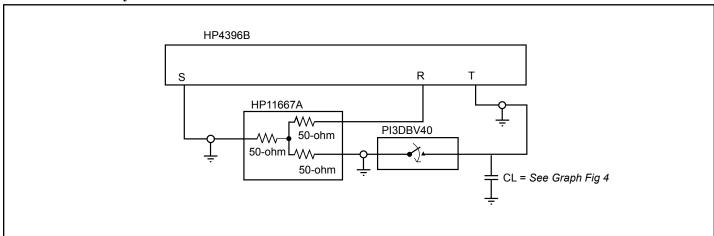


Figure 1. Bandwidth -3dB Testing

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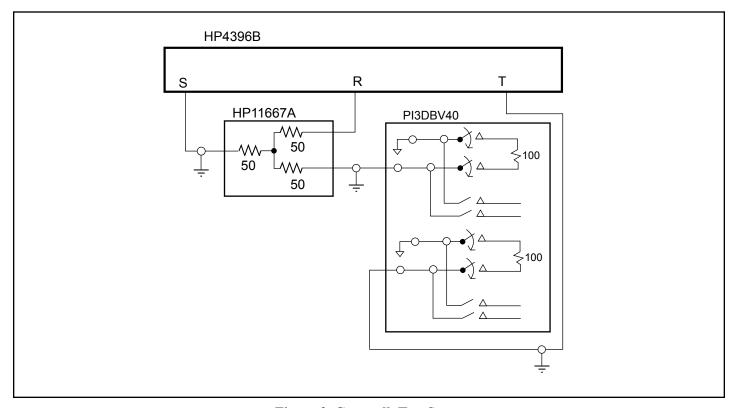


Figure 2. Crosstalk Test Setup

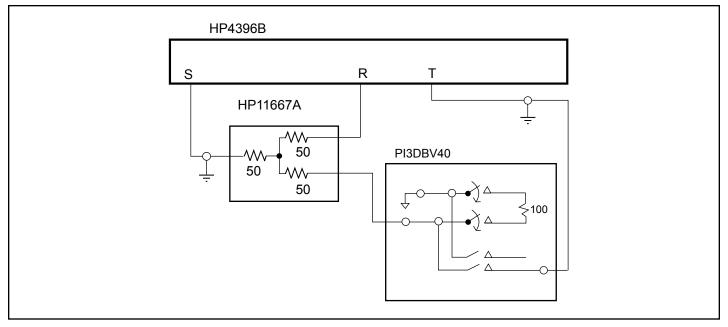


Figure 3. Off Isolation Tets Setup

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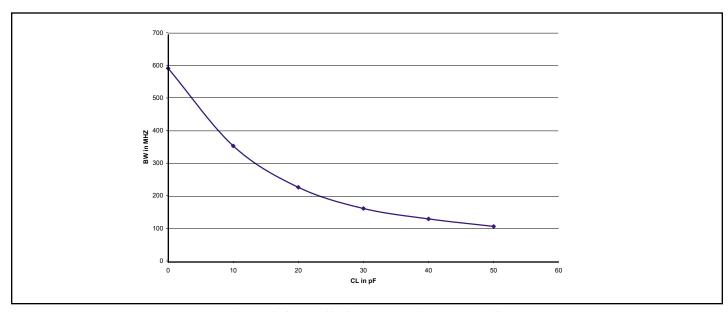
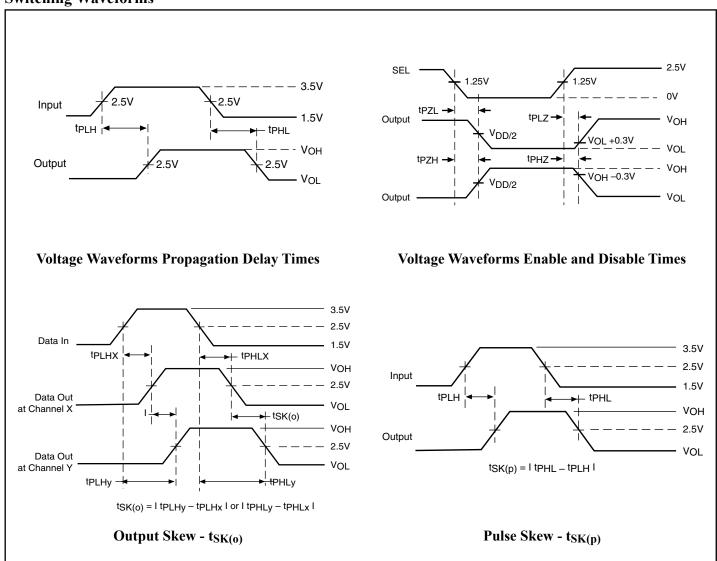


Figure 4. 3DVB40 -3dB Bandwidth versus CL

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Switching Waveforms



Applications Information

Logic Inputs

The logic control inputs can be driven up to +3.6V regardless of the supply voltage. For example, given a +3.3V supply, the output enables or select pins may be driven low to 0V and high to 3.6V. Driving IN Rail-to-Rail® minimizes power consumption.

Power-Supply Sequencing

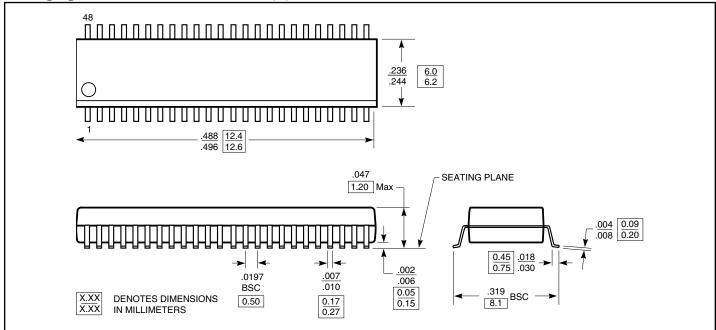
Proper power-supply sequencing is advised for all CMOS devices. It is recommended to always apply V_{CC} before applying signals to the input/output or control pins.

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Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd



Packaging Mechanical: 48-Pin TSSOP (A)



Ordering Information

Ordering Code	Package Code	Package Description
PI3DBV40A	A	48-pin 240 mil wide plastic TSSOP
PI3DBV40AE	A	Pb-free, 48-pin 240 mil wide plastic TSSOP

Notes:

1. Thermal characteristics can be found on the company web site at www.pericom.com/packaging/.

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